FDS6672A 30V N-Channel PowerTrench[®] MOSFET

Sov N-Chaimer Tower Trench

General Description

-AIRCHILD

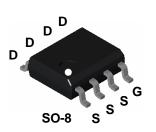
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

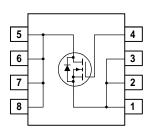
Applications

• DC/DC converter

Features

- 12.5 A, 30 V. $R_{DS(ON)} = 8 \ m\Omega @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 9.5 \ m\Omega @ V_{GS} = 4.5 \ V$
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low gate charge (33 nC typical)
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		30	V	
V _{GSS}	Gate-Source Voltage		±12	V	
I _D	Drain Current – Continuous	(Note 1a)	12.5	A	
	- Pulsed		50		
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	
Therma	I Characteristics	·		·	
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W	

R_{0JA} Thermal Resistance, Junction-to-Ambient (Note 1a) 50 °C/W R_{0JC} Thermal Resistance, Junction-to-Case (Note 1) 25 °C/W

Package Marking and Ordering Information

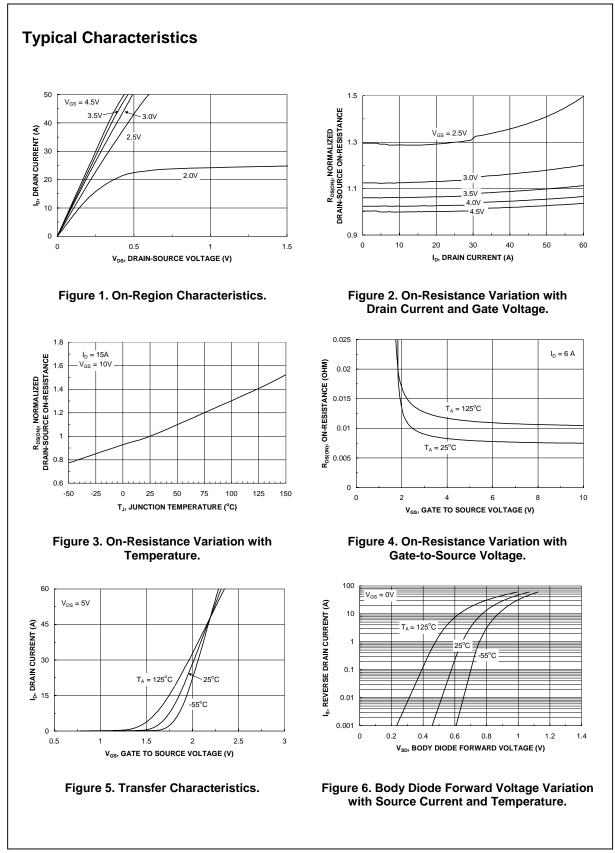
Device Marking	Device	Reel Size	Tape width	Quantity
FDS6672A	FDS6672A	13"	12mm	2500 units

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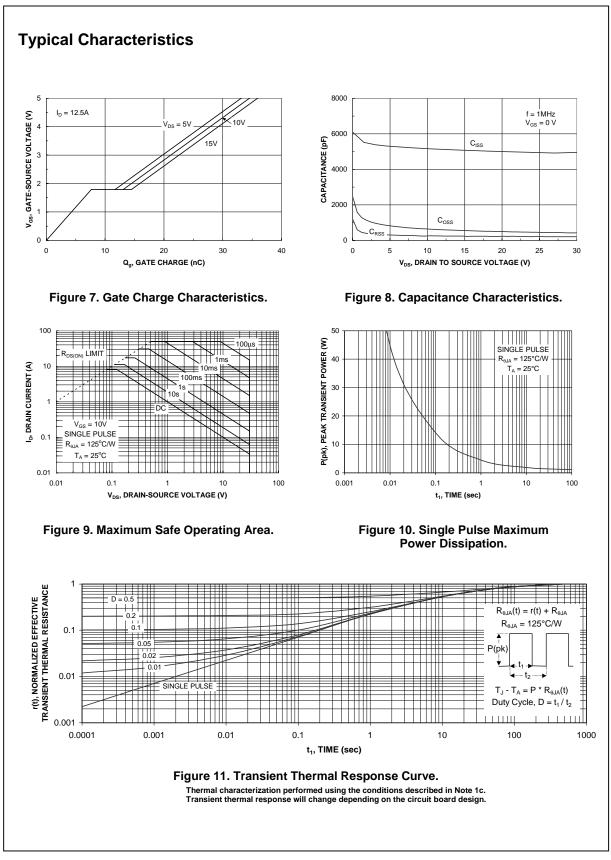
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	racteristics				1	1
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -12 V V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)			L	L	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.8	1.2	2.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			6.8 8.2 11.5	8 9.5 16	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50			A
g _{FS}	Forward Transconductance	$V_{DS} = 10 V$, $I_{D} = 15 A$		75		S
Dvnami	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		5070		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		550		pF
C _{rss}	Reverse Transfer Capacitance			230		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{\text{DD}} = 10 \text{ V}, I_{\text{D}} = 1 \text{ A},$	1	17	25	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$		18	25	ns
t _{d(off)}	Turn–Off Delay Time			69	100	ns
t _f	Turn–Off Fall Time			29	42	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, \ I_{D} = 15 \text{ A},$		33	46	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		7.5		nC
Q _{gd}	Gate-Drain Charge			6.8		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				2.1	Α
V_{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 2.1 A$ (Note 2)		0.7	1.2	V
	n of the junction-to-case and case-to-ambient then R_{eJC} is guaranteed by design while R_{eCA} is detern a) 50°/W when		ט ע	as the solde		

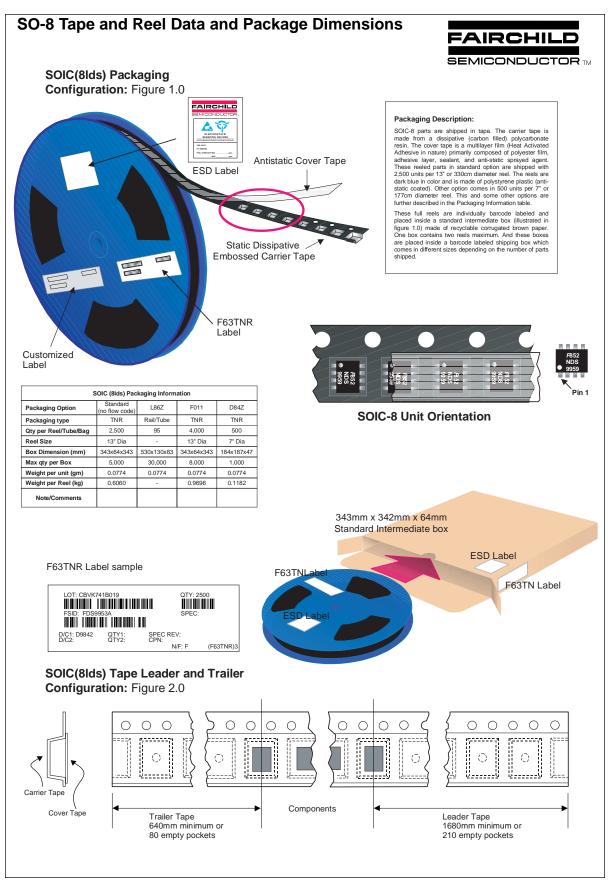
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

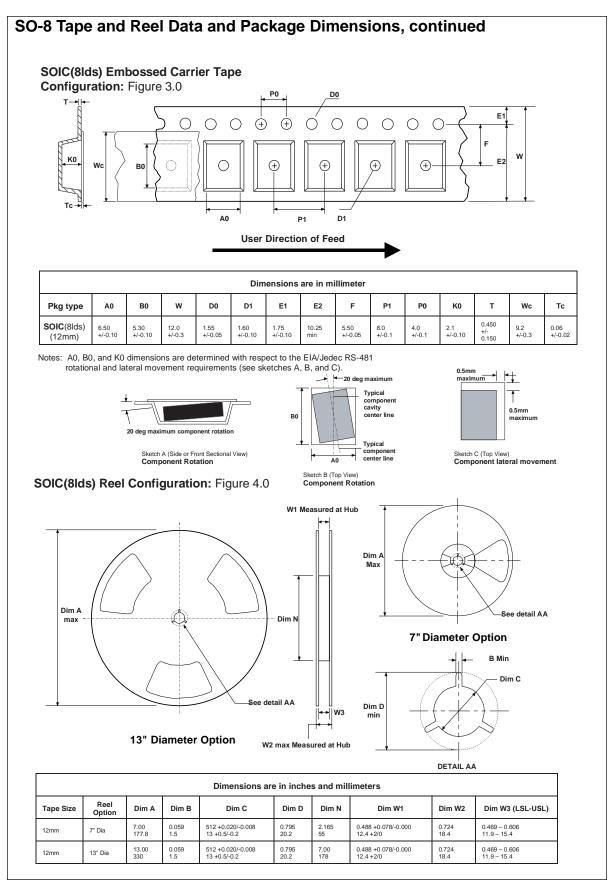


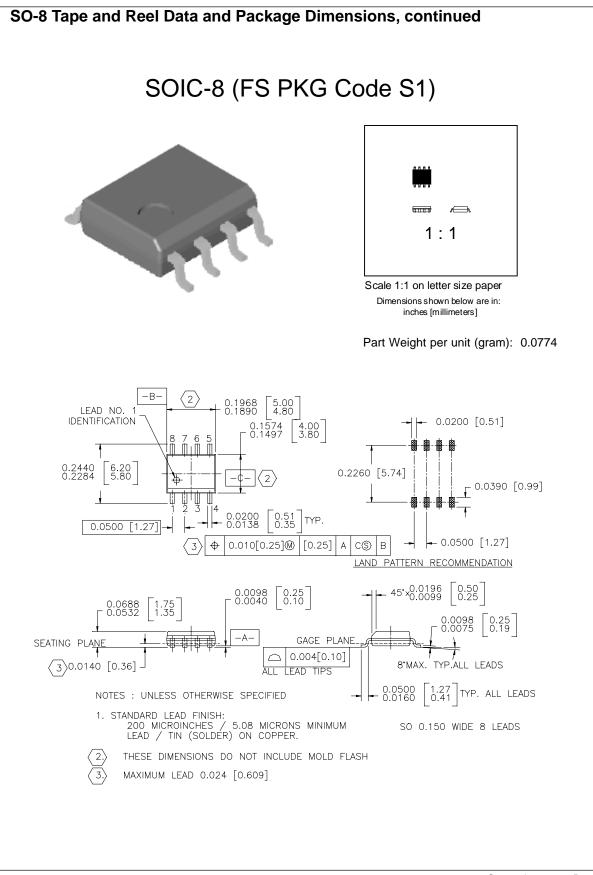
FDS6672A Rev B(W)





July 1999, Rev. B





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